



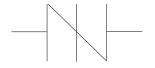
## **Agency Approvals**

Agency	Agency File Number			
<b>71</b>	E133083			

## **Pinout Designation**

Not Applicable

## Schematic Symbol



## **Description**

The Pxxx0S3N Series DO-214AB thyristors are components designed to protect equipment located in hostile environments from overvoltage transients.

The Pxxx0S3N Series protect exposed interfaces in industrial and ICT applications, such as RS-485 data interfaces or AC and DC power supplies. These components' switching voltage VS are much lower than alternative Gas Discharge Tubes (GDT), and on-state voltage VT are much lower than alternative GDTs, Metal Oxide Varistors (MOV) and TVS Diodes.

This Pxxx0S3N series are rated 2500A 8/20  $\mu$ s, enabling equipment compliance with regulatory and customer surge

#### **Features and Benefits**

- Low voltage overshoot
- Low on-state voltage
- Component properties do not degrade after multiple surge events within its limits
- Fails short circuit when surged in excess of ratings
- Fast response in microseconds

- 2500A 8/20 µs Surge Rating
- RoHS Compliant and Halogen-Free
- Pb-free E3 means 2nd level interconnect is Pb-free and the terminal finish material is tin (Sn) (IPC/JEDEC J-STD609A.01)

## **Applicable Global Standards**

- TIA-968-A
- TIA-968-B
- ITU K.20/21 Enhanced Level
- ITU K.20/21 Basic Level
- GR 1089 Inter-building
- GR 1089 Intra-building
- IEC 61000-4-5, 2nd Ed
- YD/T 1082
- YD/T 993
- YD/T 950

#### **Electrical Characteristics**

Part Number	Marking	V <sub>DRM</sub> @I <sub>DRM</sub> =5µA	V <sub>s</sub> @100V/μs	I <sub>H</sub>	I <sub>s</sub>	I <sub>T</sub>	ν <sub>τ</sub> @Ι <sub>τ</sub> =2.2A		itance , 2V bias
		V min	V max	mA min	mA max	A max	V max	pf min	pF max
P0080S3NLRP	P-8N	6	25	50	800	2.2	4	80	150
P0300S3NLRP	P03N	30	45	50	800	2.2	4	80	150

- Absolute maximum ratings measured at T<sub>A</sub>= 25°C (unless otherwise noted).
- Components are bi-directional (unless otherwise noted).

## **Surge Ratings**

Series	I <sub>PP</sub> 8/20 <sup>1</sup> 1.2/50 <sup>2</sup>	I <sub>TSM</sub> 50 / 60 Hz	di/dt	
	A min	A min	A/µs max	
N	2500	250	630	

#### Notes:

i

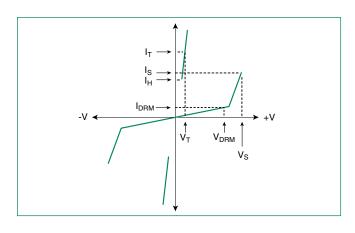
- 1. Current waveform in µs
- 2. Voltage waveform in µs
- Peak pulse current rating ( $I_{pp}$ ) is repetitive and guaranteed for the life of the product.  $I_{pp}$  ratings applicable over temperature range of -40°C to +85°C The device must initially be in thermal equilibrium with -40°C  $\leq T_{\downarrow} \leq$  +150°C



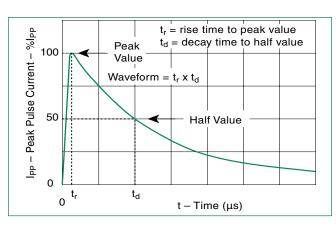
## **Thermal Considerations**

Package	Symbol	Parameter	Value	Unit
DO-214AB	T <sub>J</sub>	Operating Junction Temperature Range	-65 to +150	°C
\$0-214AB	T <sub>s</sub>	Storage Temperature Range	-65 to +150	°C
~/	R <sub>eJA</sub>	Thermal Resistance: Junction to Ambient	75	°C/W

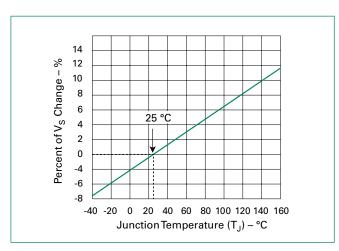
#### **V-I Characteristics**



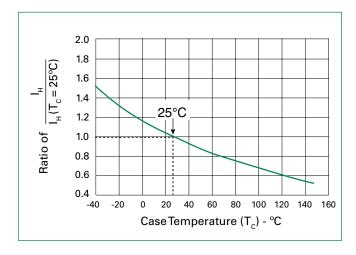
#### tr x td Pulse Waveform



## Normalized VS Change vs. Junction Temperature

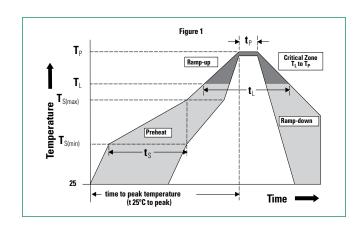


### Normalized DC Holding Current vs. Case Temperature



## **Soldering Parameters**

Reflow Cond	Pb-Free assembly (see Fig. 1)			
	-Temperature Min (T <sub>s(min)</sub> )	+150°C		
Pre Heat	- Temperature Max (T <sub>s(max)</sub> )	+200°C		
	-Time (Min to Max) (t <sub>s</sub> )	60-180 secs.		
Average ram	Average ramp up rate (Liquidus Temp (T <sub>L</sub> ) to peak)			
$T_{S(max)}$ to $T_L$ -	3°C/sec. Max.			
Reflow	- Temperature (T <sub>L</sub> ) (Liquidus)	+217°C		
	- Temperature (t <sub>L</sub> )	60-150 secs.		
Peak Temp (	Γ <sub>P</sub> )	+260(+0/-5)°C		
Time within	30 secs. Max.			
Ramp-down	6°C/sec. Max.			
Time 25°C to	8 min. Max.			
Do not exce	+260°C			



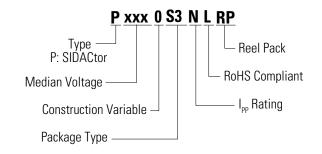
## **Physical Specifications**

Lead Material	Copper Alloy
Terminal Finish	100% Matte-Tin Plated
Body Material	UL Recognized epoxy meeting flammability
Dody Waterial	classification V-0

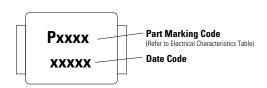
## **Environmental Specifications**

High Temp Voltage Blocking	80% Rated $V_{\rm DRM}$ ( $V_{\rm AC}$ Peak) +125°C or +150°C, 504 or 1008 hrs. MIL-STD-750 (Method 1040) JEDEC, JESD22-A-101				
Temp Cycling	-65°C to +150°C, 15 min. dwell, 10 up to 100 cycles. MIL-STD-750 (Method 1051) EIA/ JEDEC, JESD22-A104				
Biased Temp & Humidity	52 V <sub>DC</sub> (+85°C) 85%RH, 504 up to 1008 hrs. EIA/JEDEC, JESD22-A-101				
High Temp Storage	+150°C 1008 hrs. MIL-STD-750 (Method 1031) JEDEC, JESD22-A-101				
Low Temp Storage	-65°C, 1008 hrs.				
Thermal Shock	0°C to +100°C, 5 min. dwell, 10 sec. transfer, 10 cycles. MIL-STD-750 (Method 1056) JEDEC, JESD22-A-106				
Autoclave (Pressure Cooker Test)	+121°C, 100%RH, 2atm, 24 up to 168 hrs. EIA/JEDEC, JESD22-A-102				
Resistance to Solder Heat	+260°C, 30 secs. MIL-STD-750 (Method 2031)				
Moisture Sensitivity Level	85%RH, +85°C, 168 hrs., 3 reflow cycles (+260°C Peak). JEDEC-J-STD-020, Level 1				

#### **Part Numbering**

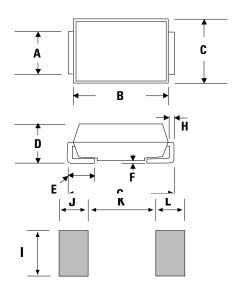


#### **Part Marking**





### Dimensions - DO-214AB

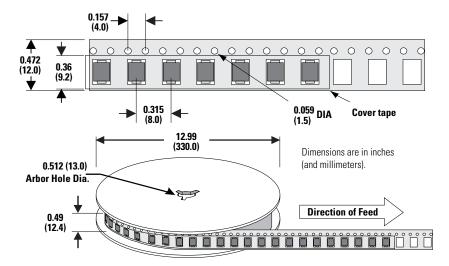


Dimensions	Inc	hes	Millimeters	
Dimensions	Min	Max	Min	Max
Α	0.114	0.126	2.900	3.200
В	0.260	0.280	6.600	7.110
С	0.220	0.245	5.590	6.220
D	0.079	0.103	2.060	2.620
E	0.030	0.060	0.760	1.520
F	-	0.008	-	0.203
G	0.305	0.320	7.750	8.130
Н	0.006	0.012	0.152	0.305
I	0.129	-	3.300	-
J	0.094	-	2.400	-
K	-	0.165	-	4.200
L	0.094	-	2.400	-

## **Packing Options**

Package Type	Description	Quantity	Added Suffix	Industry Standard
S3	DO-214AB Tape and Reel Pack	3000	RP	EIA-481-D tape and reel specification

## Tape and Reel Specification — DO-214AB



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